

Ref #	Hits	Search Query	DBs	Default Operator	Plurals	Time Stamp
L1	0	leadless same (die near1 (pad (mounting near (area portion)))) same (wire wiring) same (bond bonding bonded) same (overmold sealing encapsulant encapsulating encapsulated mold molding) same (protruded protruding protrude)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/10/30 18:00
L2	34	leadless same (die near1 (pad (mounting near (area portion)))) same (wire wiring) same (bond bonding bonded) same (overmold sealing encapsulant encapsulating encapsulated mold molding)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/10/30 17:53
L3	21	2 same (exposed expose)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/10/30 17:53

L24	466	(US-20010008305-\$ or US-20010009301-\$ or US-20020005576-\$ or US-20020019073-\$ or US-20020024127-\$ or US-20020027276-\$ or US-20020030261-\$ or US-20020031865-\$ or US-20020079563-\$ or US-20020084518-\$ or US-20020096749-\$ or US-20020109214-\$ or US-20020146864-\$ or US-20020153596-\$ or US-20020182774-\$ or US-20020192874-\$ or US-20030001244-\$ or US-20030003627-\$ or US-20030006055-\$ or US-20030052405-\$ or US-20030114024-\$ or US-20030127711-\$ or US-20030228720-\$ or US-20040070056-\$ or US-20040080025-\$ or US-20040124505-\$).did. or (US-20040262752-\$ or US-20050051877-\$ or US-20050104168-\$ or US-20050224924-\$ or US-20050218499-\$ or US-20040164387-\$ or US-20030082854-\$ or US-20020197826-\$).did. or (US-3924323-\$ or US-4388128-\$ or US-4530152-\$ or US-4862246-\$ or US-4910577-\$ or US-4918511-\$ or US-5053357-\$ or US-5122860-\$ or US-5157475-\$ or US-5157480-\$ or US-5172214-\$ or US-5200362-\$ or US-5273938-\$ or US-5299091-\$ or US-5302849-\$ or US-5365106-\$ or US-5373190-\$ or US-5397915-\$ or US-5424576-\$ or US-5424577-\$ or US-5428248-\$ or US-5436500-\$ or US-5440452-\$ or US-5444301-\$ or US-5475259-\$ or US-5519251-\$).did. or (US-5521429-\$ or US-5534467-\$ or US-5535101-\$ or US-5554823-\$ or US-5559364-\$ or US-5578871-\$ or US-5594234-\$ or US-5608265-\$ or US-5625221-\$ or US-5633206-\$ or US-5640746-\$ or US-5683943-\$ or US-5684330-\$ or US-5692296-\$ or US-5708296-\$ or US-5767566-\$ or US-5770888-\$ or US-5773313-\$ or US-5780931-\$ or US-5804874-\$ or US-5808359-\$ or US-5817545-\$ or US-5818102-\$ or US-5822100-\$	US-PGPUB; USPAT; JPO; DERWENT	OR	ON	2005/10/30 18:00
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L25	549	(die near1 (pad (mounting near (area portion)))) same (wire wiring) same (bond bonding bonded) same (overmold sealing encapsulant encapsulating encapsulated mold molding) same (protruded protruding protrude exposed expose)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/10/30 18:01
L26	214	25 same ((contact bonding bond) near1 pad)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/10/30 18:02
L27	197	26 not 2	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/10/30 18:02